L Number	Hits	Search Text	DB	Time stamp
1	2	("6653573").PN.	USPAT;	2004/06/10 08:28
			EPO; JPO;	
			DERWENT;	
			USOCR	
2	7	"5966294" "5998048" "6208000").PN.	USPAT	2004/06/10 07:59
3	65722	wiring adj (board or substrate)	USPAT;	2004/06/10 08:29
			EPO; JPO;	
			DERWENT;	
			USOCR	
4 .	8066	magnetic adj thin adj film	USPAT;	2004/06/10 08:30
			EPO; JPO;	
			DERWENT:	
			USOCR	
5	18	(wiring adj (board or substrate)) and (magnetic adj	USPAT;	2004/06/10 08:38
		thin adj film)	EPO; JPO;	2004/00/10 08.38
			DERWENT;	
			USOCR	
6	6	("3825442" "3862017" "4083098" "4581279"		0004/00/40 00:04
		"4760481" "5284696").PN.	USPAT	2004/06/10 08:31
7	1	"4219854".PN.	USPAT	2004/06/10 08:33
8	10	4760481.URPN.	USPAT	2004/06/10 08:33
9	6	("4760481" "4949209" "5065270" "5126901" "5617275" "5738931").PN.	USPAT	2004/06/10 08:36
10	18	(magnetic adj thin adj film) and (conductive adj	USPAT;	2004/06/10 08:39
		pattern)	EPO; JPO;	
			DERWENT;	
			USOCR	
11	1345	(magnetic adj thin adj film) and (pattern or foil)	USPAT;	2004/06/10 08:39
		·	EPO; JPO;	
			DERWENT;	
			USOCR	
12	987	((magnetic adj thin adj film) and (pattern or foil)) and	USPAT:	2004/06/10 08:40
		(board or substrate)	EPO; JPO;	200 1100, 10 00.40
		,	DERWENT:	
			USOCR	
13	133	(((magnetic adj thin adj film) and (pattern or foil)) and	USPAT:	2004/06/10 08:41
		(board or substrate)) and ground	EPO; JPO;	2004/00/10 08.41
		(would be outstitute)) and ground	DERWENT:	
			USOCR	
14	82	((((magnetic adj thin adj film) and (pattern or foil)) and		2004/06/40 00:44
15	02	((((magnetic adj tilin adj tilin) and (pattern or foli)) and (board or substrate)) and ground) and insulat\$3	USPAT;	2004/06/10 08:41
		(bodi a or substrate)) and ground) and insulat\$3	EPO; JPO;	
			DERWENT;	
	_	/"EC407E3" "ECC0C00" "E7707E70" "E7707C70"	USOCR	
10	5	("5640753" "5668689" "5793578" "5966800" "5969911").PN.	USPAT	2004/06/10 08:42